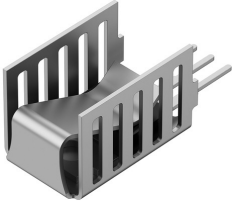


Data sheet Product FK 261 MI 220 O



Board Level heatsinks>Attachable heatsink

- universal clip-on heatsinks for design TO 220 and similar
- integrated clamp geometry for a secure fixing of the device
- angled designs with enlarged surface
- modifications and special designs according to customer's specifications

Features

| | |
|---------------------|---|
| material: | copper (Cu) |
| for transistor: | <ul style="list-style-type: none"> • TO 220 • TO 248 • SIP-Multiwatt • TO 247 • TO 218 |
| width: | 13 mm |
| height: | 13 mm |
| length: | 21 mm |
| thermal resistance: | 23.8 K/W |
| surface: | solderable surface |
| version: | without solder lug |
| material thickness: | 0.6 mm |

Technical Drawing

23,8 K/W

